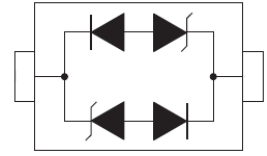


Features

- ESD / transient protection of high speed data lines
 - IEC 61000-4-2 (ESD): $\pm 30\text{kV}$ (air), $\pm 30\text{ kV}$ (contact)
- Low reverse stand-off voltage: $V_{RWM} = 24\text{V}$
- Low clamping voltage
- Unidirectional & Bidirectional Configurations
- Protects One Power or I/O Port

HF



SOD-323

Mechanical Data

- Case: SOD-323
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin-Plated Leads, Solderability-per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
DLC24C	SOD-323	3000 pcs / Tape & Reel	4C

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
IEC 61000-4-2; ESD (Air)	V_{ESD-A}	± 30	kV
IEC 61000-4-2; ESD (Contact)	V_{ESD-C}	± 30	kV
Peak Pulse Power ($t_p = 8/20\mu\text{s}$)	P_{PP}	350	W
Peak Pulse Current ($t_p = 8/20\mu\text{s}$)	I_{PP}	6	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-to-Air ^{*1}	$R_{\theta JA}$	286	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Case ^{*1}	$R_{\theta JC}$	174	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Lead ^{*1}	$R_{\theta JL}$	220	$^\circ\text{C/W}$
Junction Temperature	T_J	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$

Note 1: The data tested by surface mounted on a 25.4mm * 25.4mm * 1mm FR4-epoxy P.C.B

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Reverse Stand-off Voltage	V_{RWM}		-	-	24	V
Reverse Breakdown Voltage	$V_{(BR)}$	$I_T = 1\text{mA}$	26.7	-	-	V
Reverse Leakage Current	I_R	$V_{RWM} = 24\text{V}$	-	-	1	μA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}, t_p = 8/20\mu\text{s}$	-	-	43	V
		$I_{PP} = 6\text{A}, t_p = 8/20\mu\text{s}$	-	-	56	V
Junction Capacitance	C_J	$V_R = 0\text{V}, f = 1\text{MHz}$	-	1	-	pF

Ratings and Characteristic Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

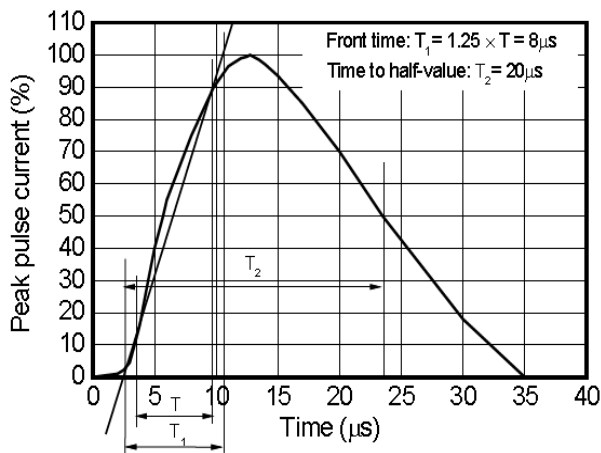


Fig 1 8/20 μs waveform per IEC61000-4-5

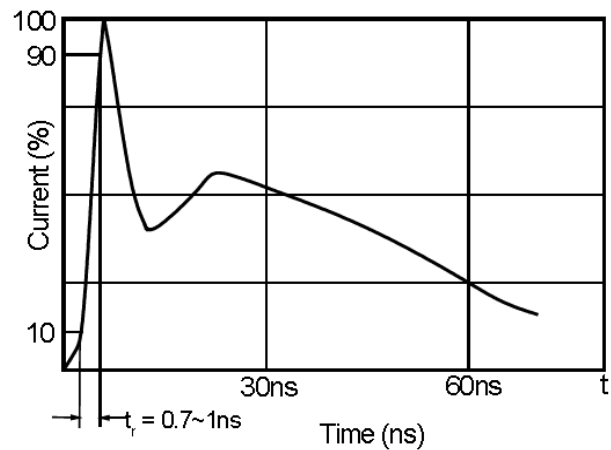


Fig 2 ESD pulse waveform according to IEC61000-4-2

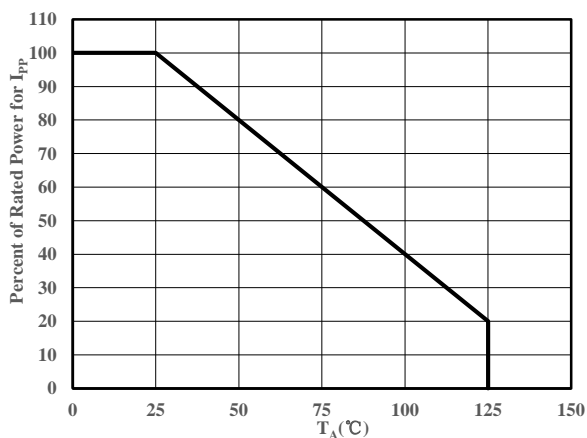
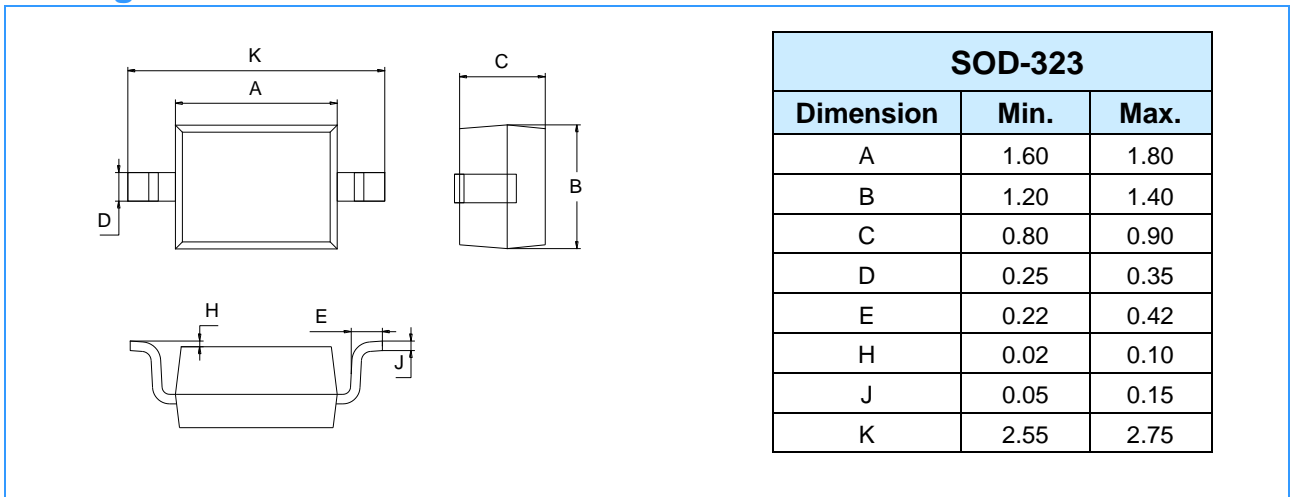
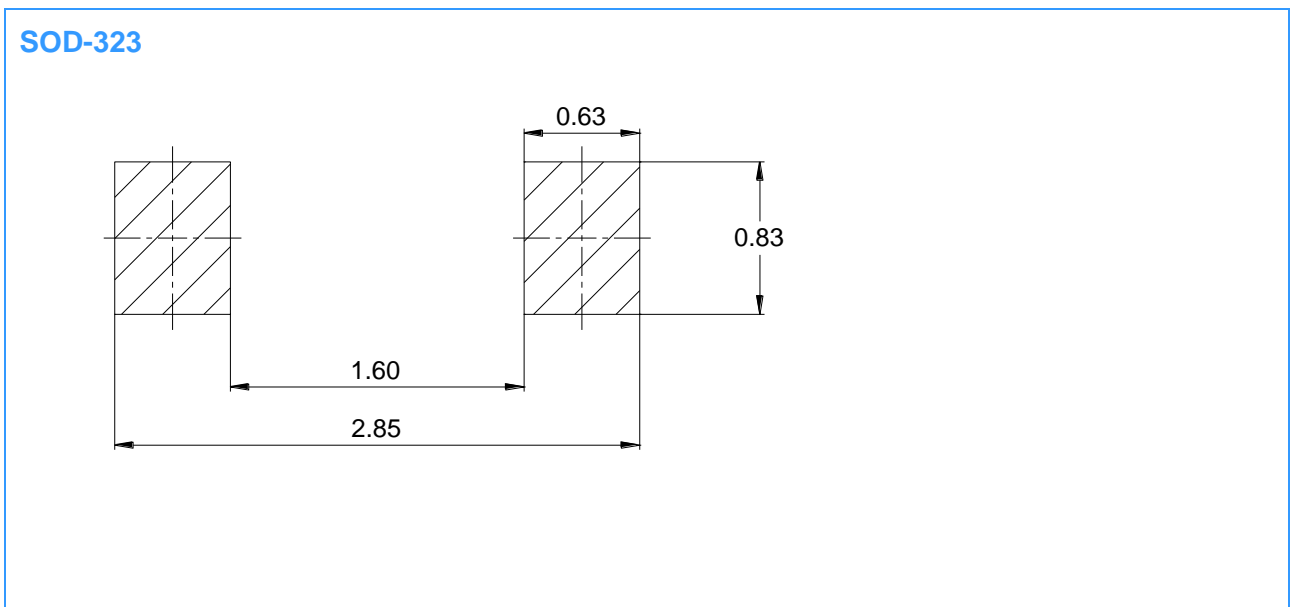


Fig 3 Power Derating Curve

Package Outline Dimensions (Unit: mm)



Package Outline Dimensions (Unit: mm)



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